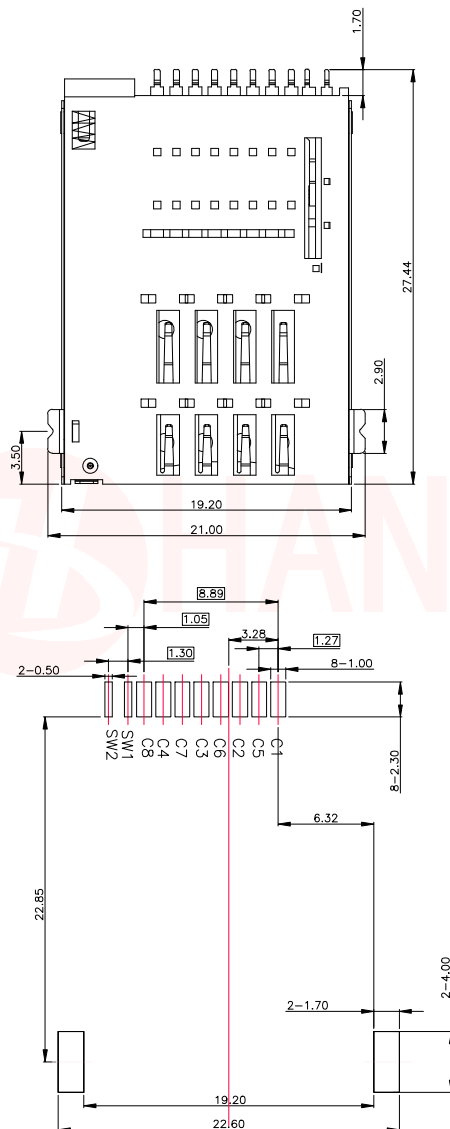
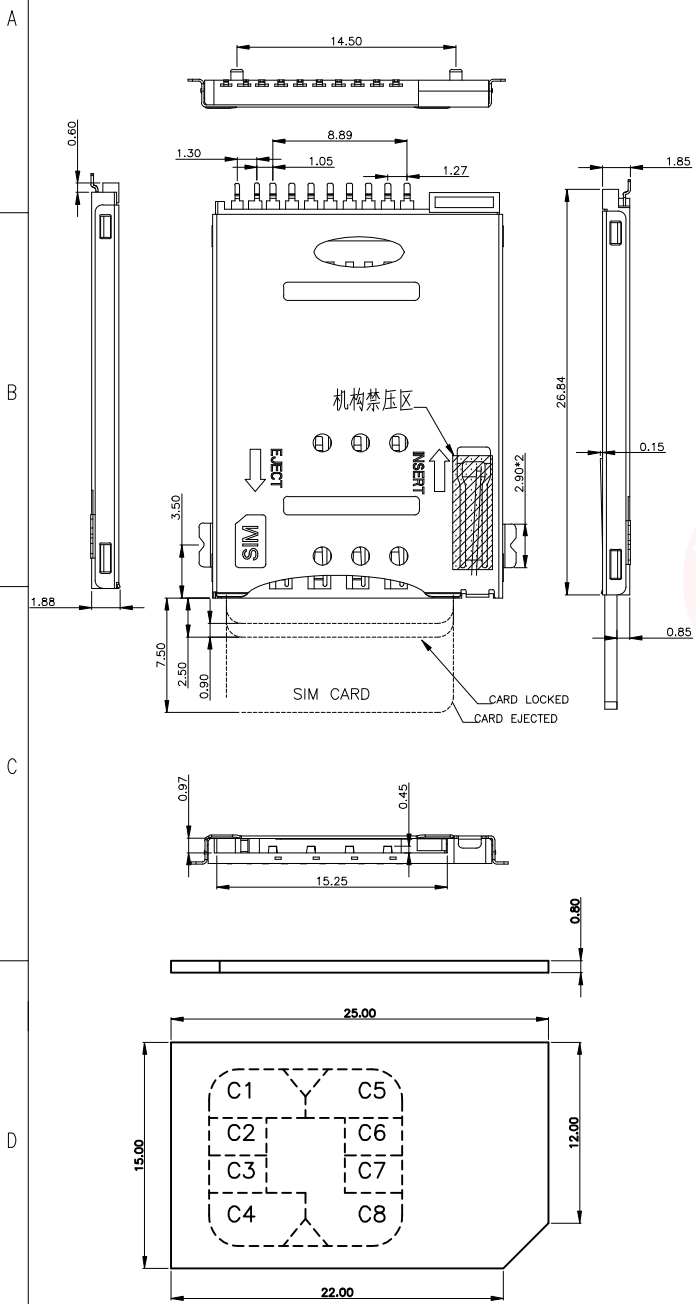
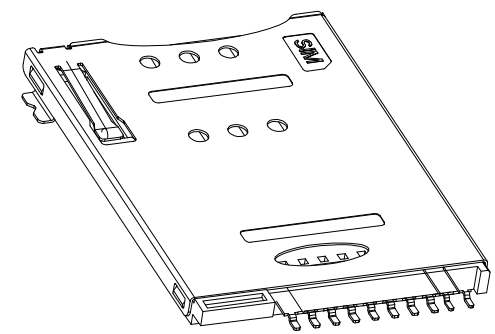




REV.	ECN NO OR DESCRIPTION	REVISED	DATE



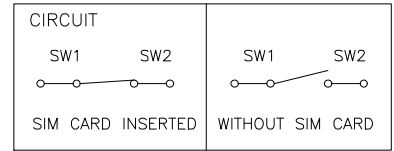
RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05



SPECIFICATION

MATERIAL:
INSULATOR: HIGH TEMPERATURE THERMOPLASTIC, UL 94V-0. COLOR: BLACK LCP
CONTACT: COPPER ALLOY
PLATING:
CONTACT: PLATED 30U" NI OVERALL
PLATED AU SELECTIVE CONTACT AREA
SHELL: PLATED 30U" NI OVERALL, PAD G/F AU
ELECTRICAL:
CURRENT RATING: 0.5AMPS
VOLTAGE RATING: 5V AC/DC
AMBIENT TEMPERATURE RANGE: -20°C~+60°C
STORAGE TEMPERATURE RANGE: -40°C~+80°C
AMBIENT HUMIDITY RANGE: 95% R.H. MAX.
CONTACT RESISTANCE: 100MΩMAX.
INSULATION RESISTANCE: 1000MΩMIN./500VDC
MATING CYCLES: 5,000 INSERTIONS
REFLOW PEAK TEMP: 260°C

pin no.	name
C1	vcc of sim
C2	rst of sim
C3	clk of sim
C5	gnd of sim
C6	vpp of sim
C7	I/O of sim
C4/C8	n/a
SW1	switch1
SW2	switch2



UNLESS OTHERWISE SPECIFIED TOLERANCES		东莞市汉博电子科技有限公司 DONGGUAN HANBO TECHNOLOGY CO., LTD	
DECIMALS:	ANGLES:	TITLE	Mini Sim Card Push Push 8+2P Smt 无桩
X :±0.5	X :±2°	DWN	xiong SIM-206
X.X :±0.20	X.X :±1°	CHKD	lee SCALE:1:1 UNIT: mm
X.XX :±0.10		APVD	wang SIZE: A4 SHEET:10F 1
		REV: A4	
CUSTOMER COPY			